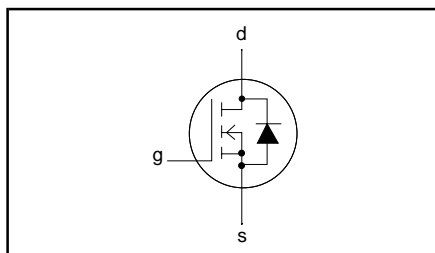


**SiliconMAX****N-channel TrenchMOS™ transistor****PSMN015-100B, PSMN015-100P****FEATURES**

- 'Trench' technology
- Very low on-state resistance
- Fast switching
- Low thermal resistance

**SYMBOL****QUICK REFERENCE DATA**

$$V_{DSS} = 100 \text{ V}$$

$$I_D = 75 \text{ A}$$

$$R_{DS(ON)} \leq 15 \text{ m}\Omega$$

**GENERAL DESCRIPTION**

**SiliconMAX** products use the latest Philips Trench technology to achieve the lowest possible on-state resistance in each package at each voltage rating.

**Applications:-**

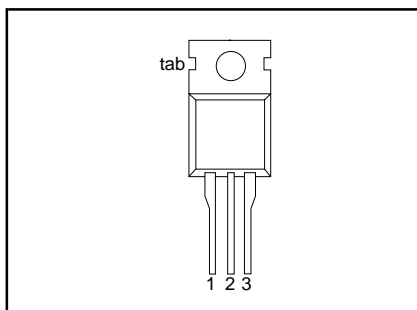
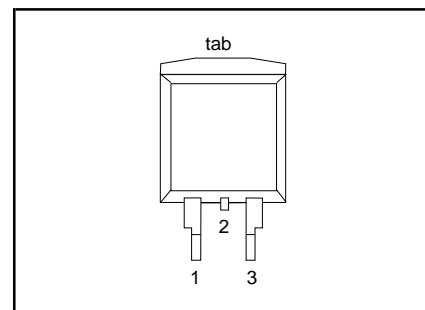
- d.c. to d.c. converters
- switched mode power supplies

The PSMN015-100P is supplied in the SOT78 (TO220AB) conventional leaded package.

The PSMN015-100B is supplied in the SOT404 surface mounting package.

**PINNING**

PIN	DESCRIPTION
1	gate
2	drain <sup>1</sup>
3	source
tab	drain

**SOT78 (TO220AB)****SOT404 (D<sup>2</sup>PAK)****LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DSS}$	Drain-source voltage	$T_j = 25 \text{ }^\circ\text{C}$ to $175 \text{ }^\circ\text{C}$	-	100	V
$V_{DGR}$	Drain-gate voltage	$T_j = 25 \text{ }^\circ\text{C}$ to $175 \text{ }^\circ\text{C}$ ; $R_{GS} = 20 \text{ k}\Omega$	-	100	V
$V_{GS}$	Gate-source voltage		-	$\pm 20$	V
$I_D$	Continuous drain current	$T_{mb} = 25 \text{ }^\circ\text{C}$	-	$75^2$	A
		$T_{mb} = 100 \text{ }^\circ\text{C}$	-	60.8	A
$I_{DM}$	Pulsed drain current	$T_{mb} = 25 \text{ }^\circ\text{C}$	-	240	A
$P_D$	Total power dissipation	$T_{mb} = 25 \text{ }^\circ\text{C}$	-	300	W
$T_j, T_{stg}$	Operating junction and storage temperature		- 55	175	$^\circ\text{C}$

<sup>1</sup> It is not possible to make connection to pin:2 of the SOT404 package

<sup>2</sup> Maximum continuous current limited by package

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**AVALANCHE ENERGY LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$E_{AS}$	Non-repetitive avalanche energy	Unclamped inductive load, $I_{AS} = 74$ A; $t_p = 100$ $\mu$ s; $T_j$ prior to avalanche = 25°C; $V_{DD} \leq 50$ V; $R_{GS} = 50$ $\Omega$ ; $V_{GS} = 10$ V; refer to fig:15	-	481	mJ
$I_{AS}$	Non-repetitive avalanche current		-	75	A

**THERMAL RESISTANCES**

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base		-	0.5	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	SOT78 package, in free air SOT404 package, pcb mounted, minimum footprint	60 50	- -	K/W K/W

**ELECTRICAL CHARACTERISTICS** $T_j = 25^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0$ V; $I_D = 0.25$ mA; $T_j = -55^\circ\text{C}$	100 89	- -	- -	V V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ ; $I_D = 1$ mA $T_j = 175^\circ\text{C}$ $T_j = -55^\circ\text{C}$	2.0 1.0 -	3.0 -	4.0 -	V V V
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 10$ V; $I_D = 25$ A $T_j = 175^\circ\text{C}$	- -	12 -	15 41	m $\Omega$ m $\Omega$
$I_{GSS}$	Gate source leakage current	$V_{GS} = \pm 10$ V; $V_{DS} = 0$ V	-	2	100	nA
$I_{DSS}$	Zero gate voltage drain current	$V_{DS} = 100$ V; $V_{GS} = 0$ V; $T_j = 175^\circ\text{C}$	-	0.05	10 500	$\mu$ A $\mu$ A
$Q_{g(tot)}$	Total gate charge	$I_D = 75$ A; $V_{DD} = 80$ V; $V_{GS} = 10$ V	-	109	-	nC
$Q_{gs}$	Gate-source charge		-	20	-	nC
$Q_{gd}$	Gate-drain (Miller) charge		-	50	-	nC
$t_{d\ on}$	Turn-on delay time	$V_{DD} = 50$ V; $R_D = 1.8$ $\Omega$ ;	-	30	-	ns
$t_r$	Turn-on rise time	$V_{GS} = 10$ V; $R_G = 5.6$ $\Omega$	-	80	-	ns
$t_{d\ off}$	Turn-off delay time	Resistive load	-	150	-	ns
$t_f$	Turn-off fall time		-	95	-	ns
$L_d$	Internal drain inductance	Measured from tab to centre of die	-	3.5	-	nH
$L_d$	Internal drain inductance	Measured from drain lead to centre of die	-	4.5	-	nH
$L_s$	Internal source inductance	Measured from source lead to source bond pad	-	7.5	-	nH
$C_{iss}$	Input capacitance	$V_{GS} = 0$ V; $V_{DS} = 25$ V; $f = 1$ MHz	-	4720	-	pF
$C_{oss}$	Output capacitance		-	650	-	pF
$C_{riss}$	Feedback capacitance		-	380	-	pF

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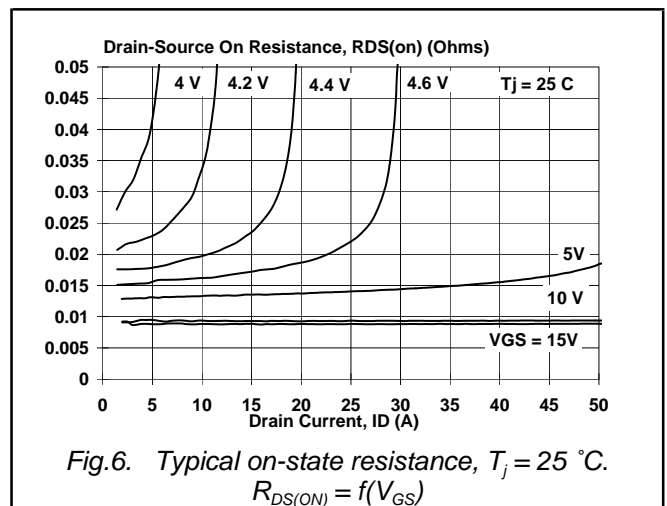
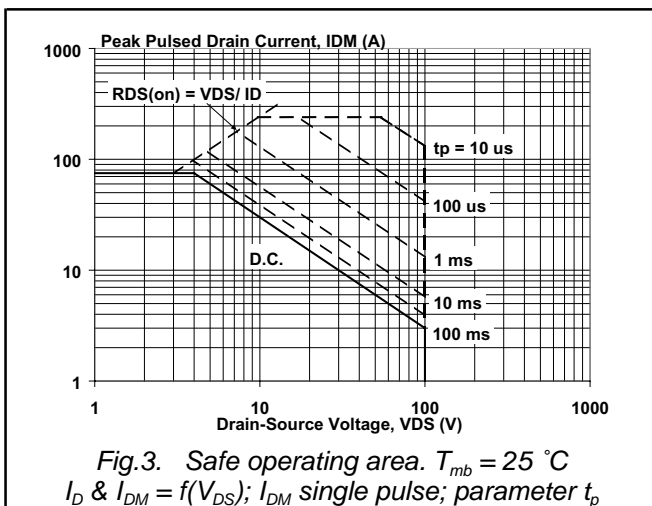
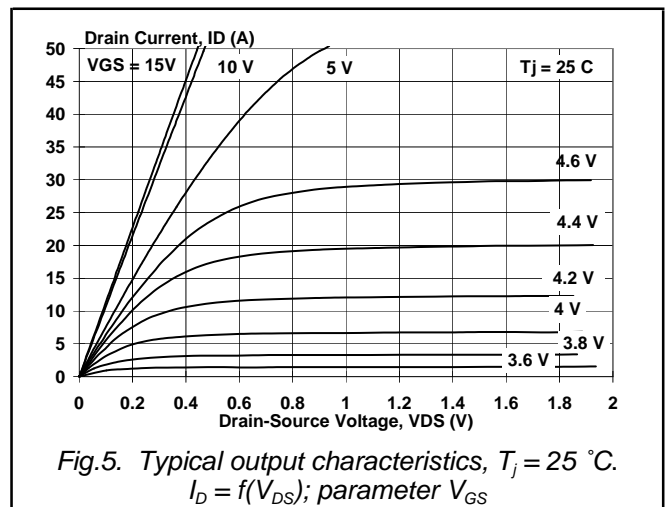
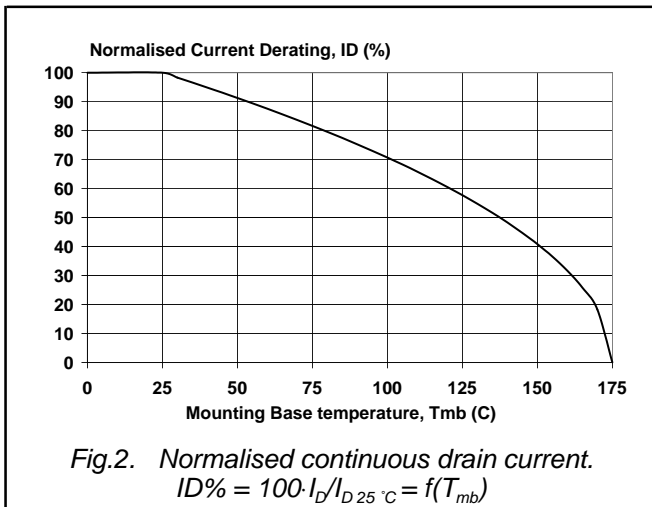
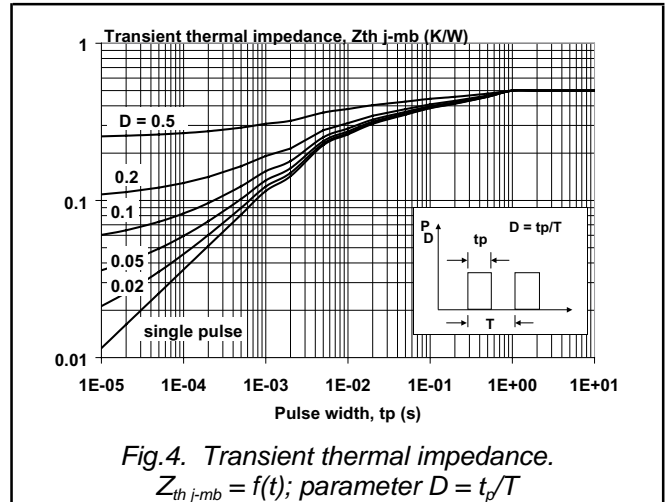
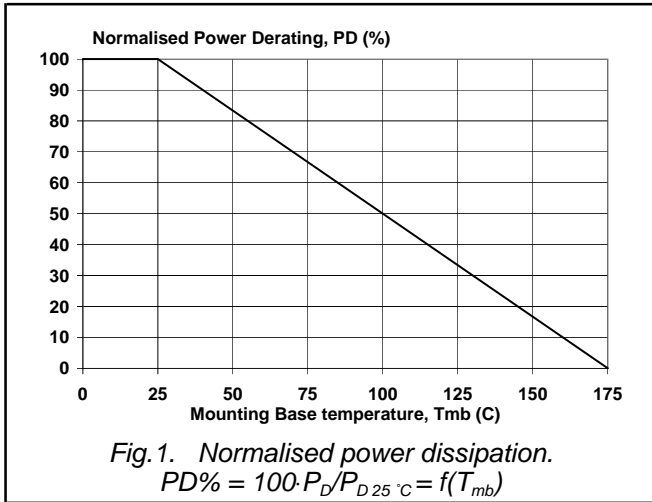
**REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS** $T_j = 25^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_S$	Continuous source current (body diode)		-	-	75	A
$I_{SM}$	Pulsed source current (body diode)		-	-	240	A
$V_{SD}$	Diode forward voltage	$I_F = 25\text{ A}; V_{GS} = 0\text{ V}$	-	0.8	1.2	V
$t_{rr}$	Reverse recovery time	$I_F = 20\text{ A}; -dI_F/dt = 100\text{ A}/\mu\text{s};$	-	90	-	ns
$Q_{rr}$	Reverse recovery charge	$V_{GS} = 0\text{ V}; V_R = 30\text{ V}$	-	0.3	-	$\mu\text{C}$

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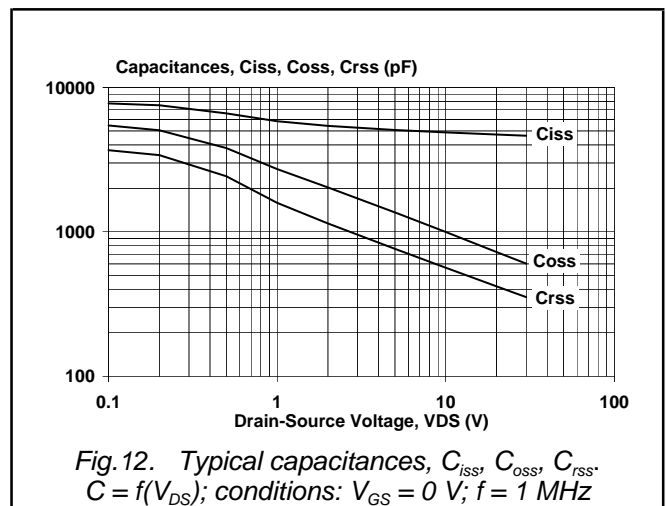
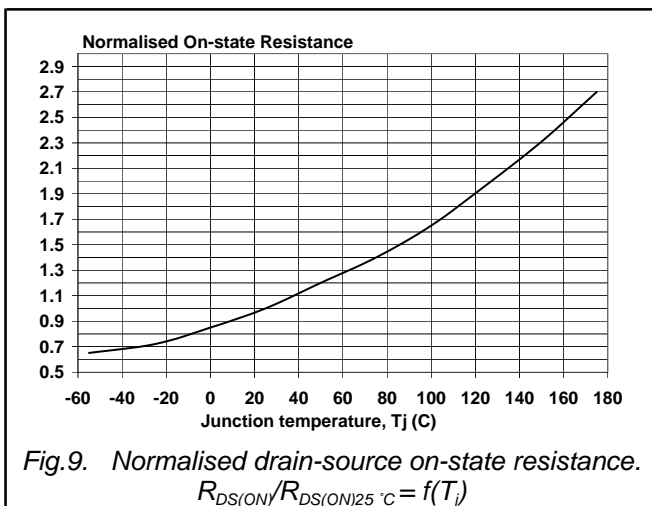
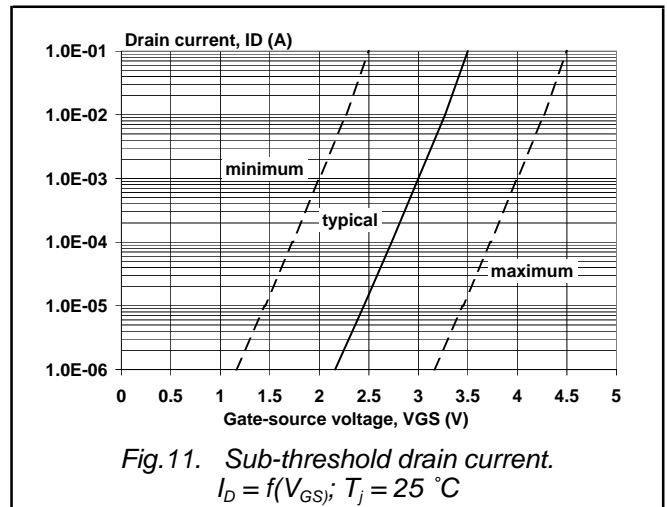
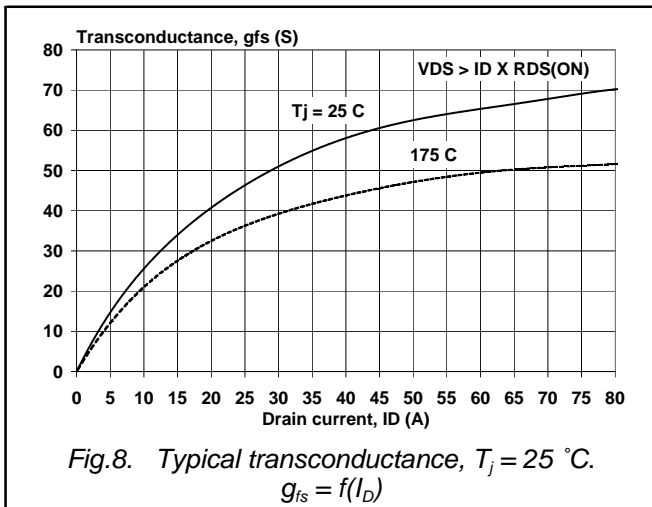
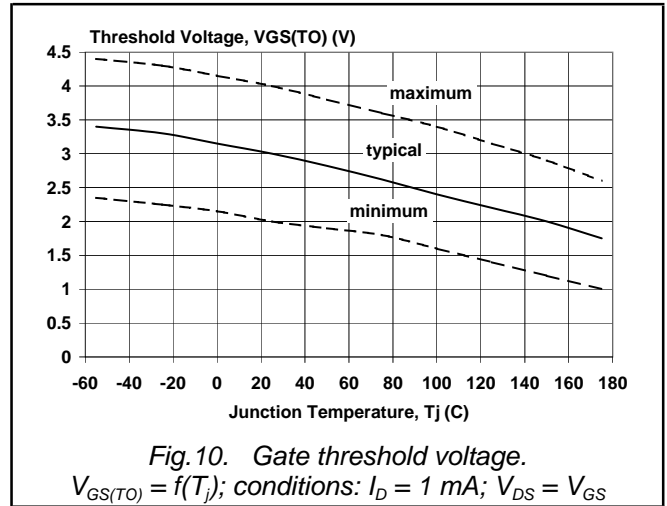
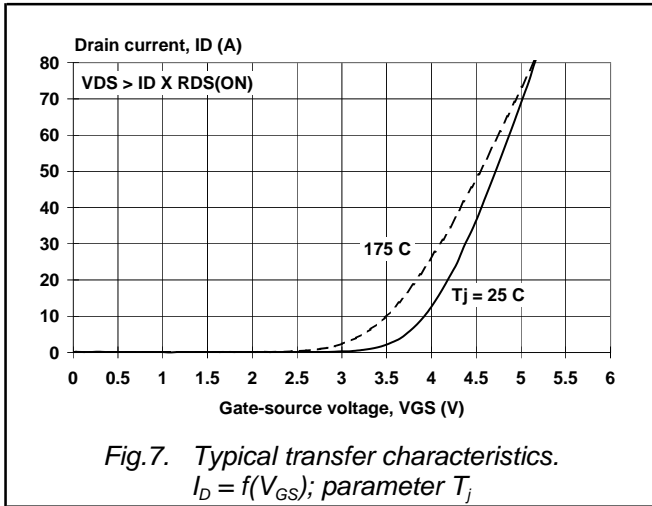
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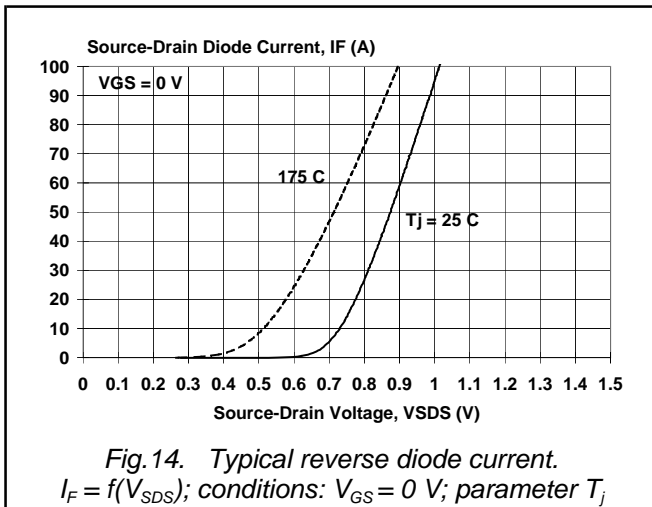
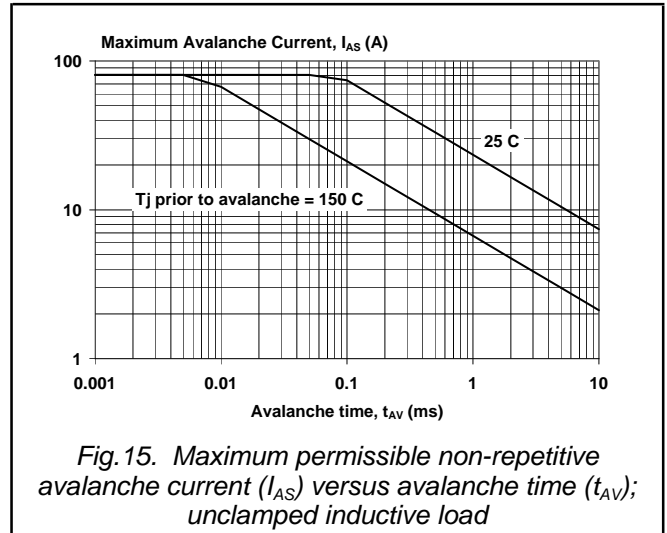
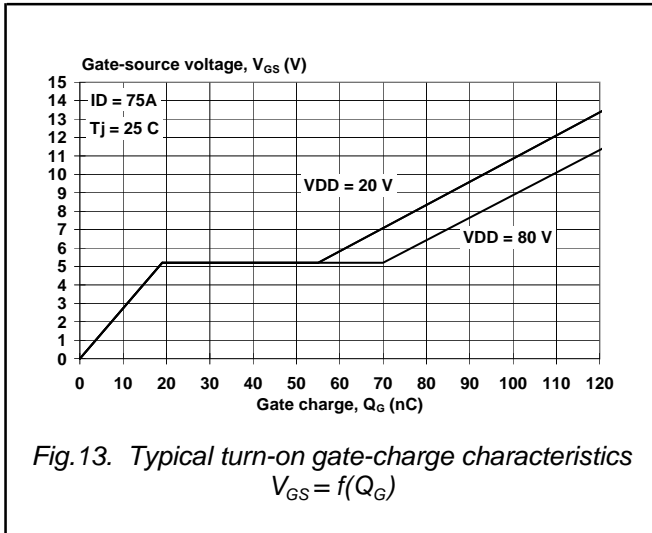
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MECHANICAL DATA

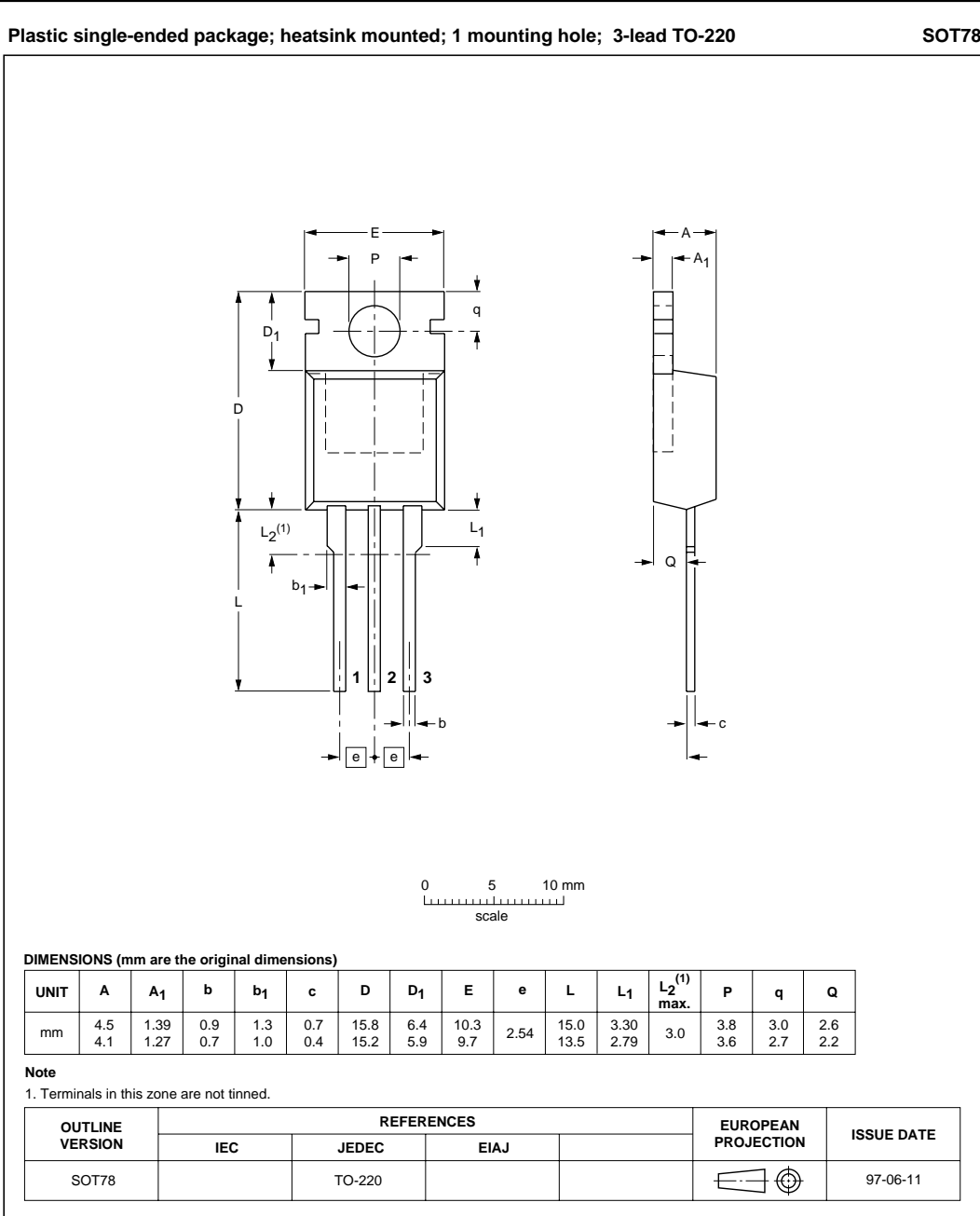


Fig.16. SOT78 (TO220AB); pin 2 connected to mounting base (Net mass:2g)

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to mounting instructions for SOT78 (TO220AB) package.
3. Epoxy meets UL94 V0 at 1/8".



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MECHANICAL DATA

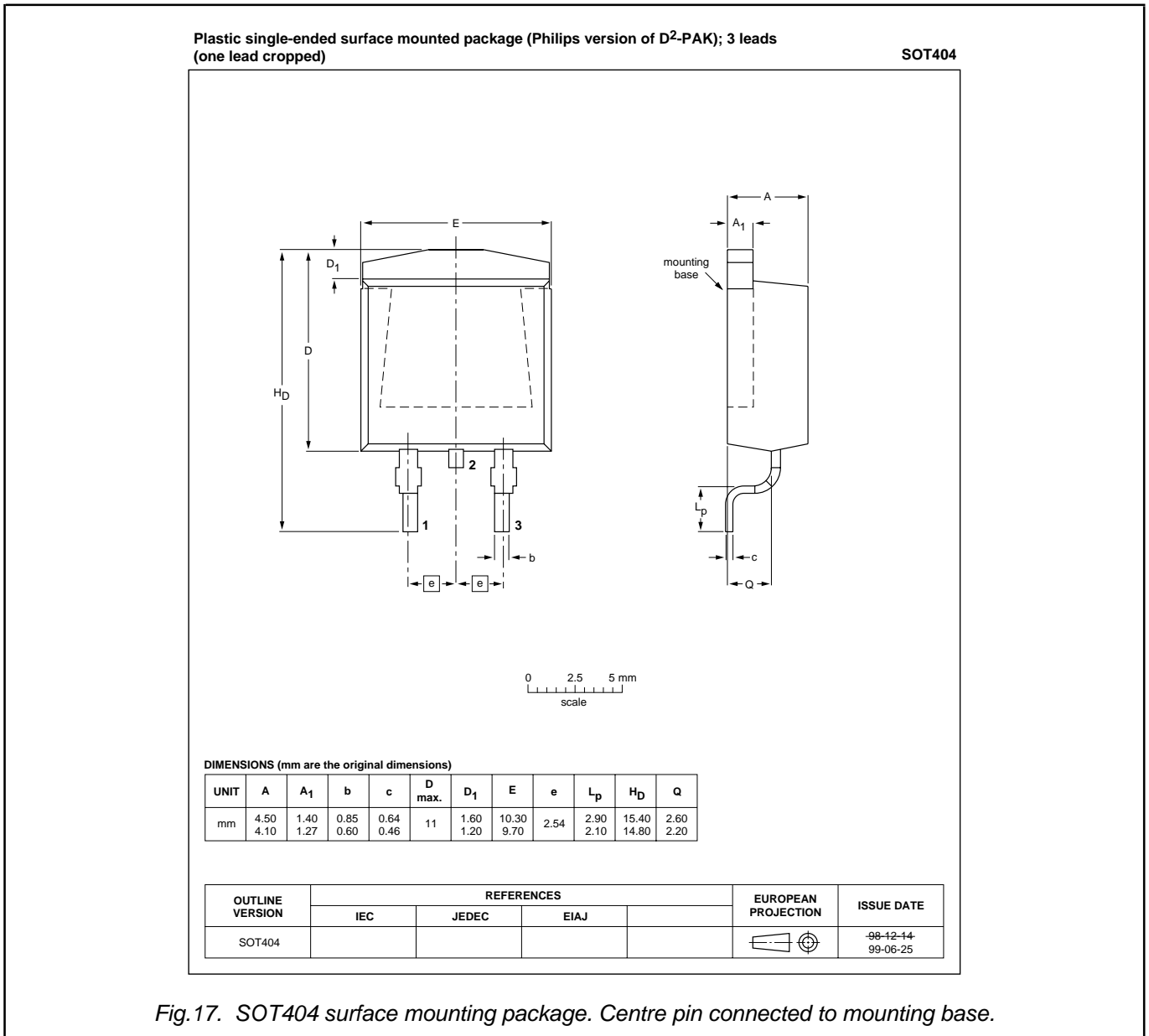


Fig.17. SOT404 surface mounting package. Centre pin connected to mounting base.

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

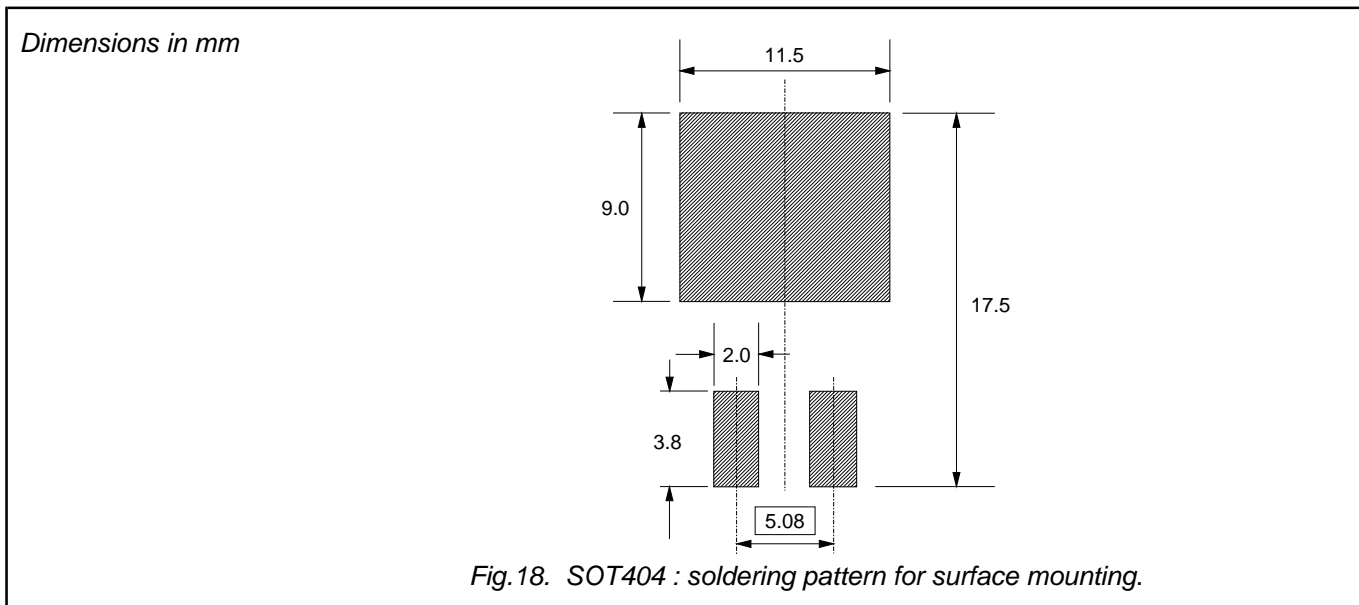




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**MOUNTING INSTRUCTIONS**



**DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	
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